

January 2016

1N5221B - 1N5263B Zener Diodes





DO-35 Glass case
COLOR BAND DENOTES CATHODE

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit	
В	Power Dissipation	500	mW	
P_{D}	Derate above 50°C	4.0	mW°C	
T _{STG}	Storage Temperature Range	-65 to +200 °C		
TJ	Operating Junction Temperature Range	-65 to +200	°C	
	Lead Temperature (1/16 inch from case for 10 s)	+230	°C	

Note:

1. These ratings are limiting values above which the serviceability of any semiconductor device may be impaired. Non-recurrent square wave Pulse Width = 8.3 ms, $T_A = 50 ^{\circ}\text{C}$

Electrical Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted .

Device	V _Z (V) @ I _Z ⁽²⁾		7 (0) 6) (m, A)	7 (0) 6) /res A \	1 (A)	av ^^	T _C	
	Min.	Тур.	Max.	$Z_{Z}(\Omega) @ I_{Z}(mA)$		$Z_{ZK}(\Omega) @ I_{ZK}(mA)$		I _R (μA) @ V _R (V)		(%/°C)
1N5221B	2.28	2.4	2.52	30	20	1,200	0.25	100	1.0	-0.08
1N5222B	2.375	2.5	2.625	30	20	1,250	0.25	100	1.0	-0.08
1N5223B	2.565	2.7	2.835	30	20	1,300	0.25	75	1.0	-0.08
1N5224B	2.66	2.8	2.94	30	20	1,400	0.25	75	1.0	-0.08
1N5225B	2.85	3	3.15	29	20	1,600	0.25	50	1.0	-0.07
1N5226B	3.135	3.3	3.465	28	20	1,600	0.25	25	1.0	-0.07
1N5227B	3.42	3.6	3.78	24	20	1,700	0.25	15	1.0	-0.06
1N5228B	3.705	3.9	4.095	23	20	1,900	0.25	10	1.0	-0.06
1N5229B	4.085	4.3	4.515	22	20	2,000	0.25	5.0	1.0	+/-0.0
1N5230B	4.465	4.7	4.935	19	20	1,900	0.25	5.0	2.0	+/-0.0
1N5231B	4.845	5.1	5.355	17	20	1,600	0.25	5.0	2.0	+/-0.0
1N5232B	5.32	5.6	5.88	11	20	1,600	0.25	5.0	3.0	0.03
1N5233B	5.7	6	6.3	7.0	20	1,600	0.25	5.0	3.5	0.038
1N5234B	5.89	6.2	6.51	7.0	20	1,000	0.25	5.0	4.0	0.04
1N5235B	6.46	6.8	7.14	5.0	20	750	0.25	3.0	5.0	0.05
1N5236B	7.125	7.5	7.875	6.0	20	500	0.25	3.0	6.0	0.05
1N5237B	7.79	8.2	8.61	8.0	20	500	0.25	3.0	6.5	0.06
1N5238B	8.265	8.7	9.135	8.0	20	600	0.25	3.0	6.5	0.06
1N5239B	8.645	9.1	9.555	10	20	600	0.25	3.0	7.0	0.06
1N5240B	9.5	10	10.5	17	20	600	0.25	3.0	8.0	0.07
1N5241B	10.45	11	11.55	22	20	600	0.25	2.0	8.4	0.07
1N5242B	11.4	12	12.6	30	20	600	0.25	1.0	9.1	0.07
1N5243B	12.35	13	13.65	13	9.5	600	0.25	0.5	9.9	0.07
1N5244B	13.3	14	14.7	15	9.0	600	0.25	0.1	10	0.08
1N5245B	14.25	15	15.75	16	8.5	600	0.25	0.1	11	0.08
1N5246B	15.2	16	16.8	17	7.8	600	0.25	0.1	12	0.08
1N5247B	16.15	17	17.85	19	7.4	600	0.25	0.1	13	0.08
1N5248B	17.1	18	18.9	21	7.0	600	0.25	0.1	14	0.08
1N5249B	18.05	19	19.95	23	6.6	600	0.25	0.1	14	0.08
1N5250B	19	20	21	25	6.2	600	0.25	0.1	15	0.08
1N5251B	20.9	22	23.1	29	5.6	600	0.25	0.1	17	0.08
1N5252B	22.8	24	25.2	33	5.2	600	0.25	0.1	18	0.08
1N5253B	23.75	25	26.25	35	5.0	600	0.25	0.1	19	0.08
1N5254B	25.65	27	28.35	41	4.6	600	0.25	0.1	21	0.08
1N5255B	26.6	28	29.4	44	4.5	600	0.25	0.1	21	0.09
1N5256B	28.5	30	31.5	49	4.2	600	0.25	0.1	23	0.09
1N5257B	31.35	33	34.65	58	3.8	700	0.25	0.1	25	0.09
1N5258B	34.2	36	37.8	70	3.4	700	0.25	0.1	27	0.09
1N5259B	37.05	39	40.95	80	3.2	800	0.25	0.1	30	0.09
1N5260B	40.85	43	45.15	93	3.0	900	0.25	0.1	33	0.09
1N5261B	44.65	47	49.35	105	2.7	1000	0.25	0.1	36	0.09
1N5262B	48.45	51	53.55	125	2.5	1100	0.25	0.1	39	0.09
1N5263B	53.2	56	58.8	150	2.2	1300	0.25	0.1	43	0.09

V_F Forward Voltage = 1.2V Max. @ I_F = 200mA

Note:

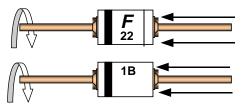
2. Zener Voltage (V_Z)

The zener voltage is measured with the device junction in the thermal equilibrium at the lead temperature (T_L) at 30°C ± 1°C and 3/8" lead length.

Top Mark Information

Device	Line 1	Line 2	Line 3
1N5221B	LOGO	22	1B
1N5222B	LOGO	22	2B
1N5223B	LOGO	22	3B
1N5224B	LOGO	22	4B
1N5225B	LOGO	22	5B
1N5226B	LOGO	22	6B
1N5227B	LOGO	22	7B
1N5228B	LOGO	22	8B
1N5229B	LOGO	22	9B
1N5230B	LOGO	23	0B
1N5231B	LOGO	23	1B
1N5232B	LOGO	23	2B
1N5233B	LOGO	23	3B
1N5234B	LOGO	23	4B
1N5235B	LOGO	23	5B
1N5236B	LOGO	23	6B
1N5237B	LOGO	23	7B
1N5238B	LOGO	23	8B
1N5239B	LOGO	23	9B
1N5240B	LOGO	24	0B
1N5241B	LOGO	24	1B
1N5242B	LOGO	24	2B
1N5243B	LOGO	24	3B
1N5244B	LOGO	24	4B
1N5245B	LOGO	24	5B
1N5246B	LOGO	24	6B
1N5247B	LOGO	24	7B
1N5248B	LOGO	24	8B
1N5249B	LOGO	24	9B
1N5250B	LOGO	25	0B
1N5251B	LOGO	25	1B
1N5252B	LOGO	25	2B
1N5253B	LOGO	25	3B
1N5254B	LOGO	25	4B
1N5255B	LOGO	25	5B
1N5256B	LOGO	25	6B
1N5257B	LOGO	25	7B
1N5258B	LOGO	25	8B
1N5259B	LOGO	25	9B
1N5260B	LOGO	26	0B
1N5261B	LOGO	26	1B
1N5262B	LOGO	26	2B
1N5263B	LOGO	26	3B

Top Mark Information (Continued)



1st line: F - Fairchild Logo

 2^{nd} line: Device Name - 4^{th} to 5^{th} characters of the device name. or 5^{th} to 6^{th} characters for BZXyy series

3rd line: Device Name - 6th to 7th characters of the device name. or Voltage rating for BZXyy series

General Requirements:

1.0 Cathode Band

2.0 First Line: F - Fairchild Logo

3.0 Second Line: Device name - For 1Nxx series: 4th to 5th characters of the device name.

For BZxx series: 5th to 6th characters of the device name.

4.0 Third Line: Device name - For 1Nxx series: 6th to 7th characters of the device name.

For BZXyy series: Voltage rating

5.0 Devices shall be marked as required in the device specification (PID or FSC Test Spec).

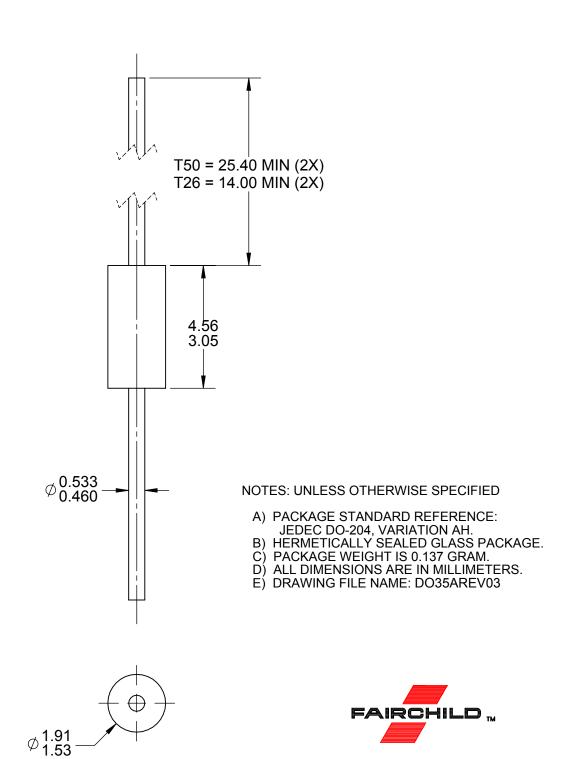
6.0 Maximum no. of marking lines: 37.0 Maximum no. of digits per line: 2

8.0 FSC logo must be 20 % taller than the alphanumeric marking and should occupy the 2 characters of the specified line.

9.0 Marking Font: Arial (Except FSC Logo)

10.0 First character of each marking line must be aligned vertically.

11.0 All device markings must be based on Fairchild device specification.







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Definition of Terms

Definition of Terms				
Datasheet Identification	Product Status	Definition		
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
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